Octal D-type flip-flop with 5 V tolerant inputs/outputs; positive edge-trigger; 3-state

Rev. 5 — 18 December 2012

**Product data sheet** 

### 1. General description

The 74LVC574A is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock (CP) and an Output Enable (OE) input are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW to HIGH CP transition.

When  $\overline{OE}$  is LOW, the contents of the eight flip-flops are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

The 74LVC574A is functionally identical to the 74LVC374A, but has a different pin arrangement.

### 2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V<sub>CC</sub> = 0 V
- 8-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Flow-through pin-out architecture
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

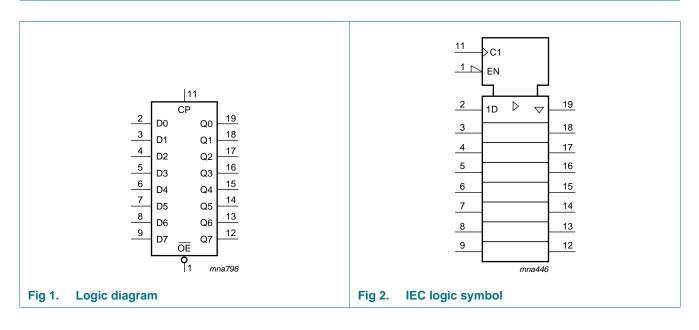


Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

## 3. Ordering information

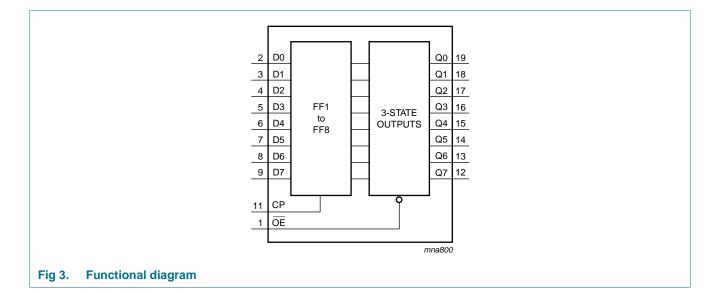
Type number	Package								
	Temperature range	Name	Description	Version					
74LVC574AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
74LVC574ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1					
74LVC574APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74LVC574ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1					

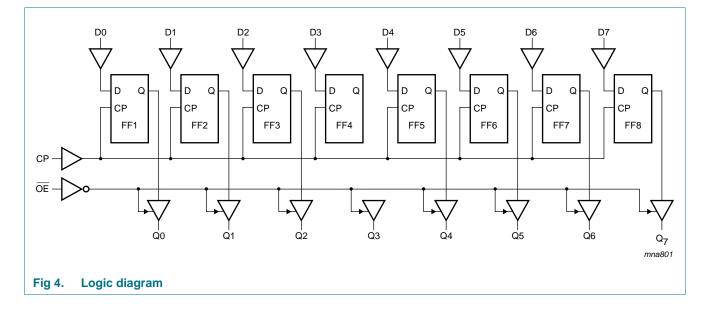
## 4. Functional diagram



# 74LVC574A

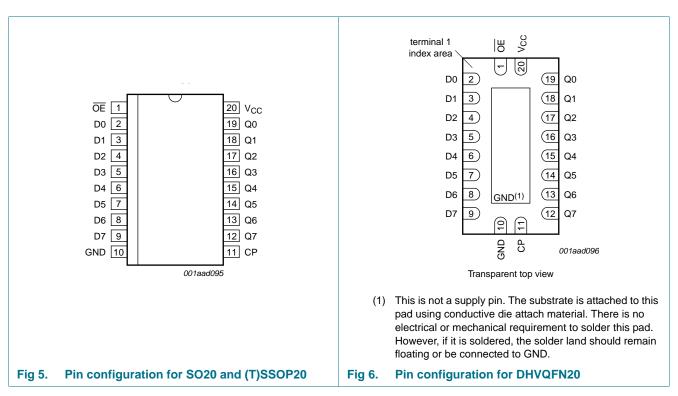
Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state





Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

## 5. Pinning information



### 5.1 Pinning

### 5.2 Pin description

Symbol	Pin	Description
Cymbol		Description
OE	1	output enable input (active LOW)
СР	11	clock input (LOW to HIGH; edge triggered)
D[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
Q[0:7]	19, 18, 17, 16, 15, 14, 13, 12	data output
GND	10	ground (0 V)
V <sub>CC</sub>	20	supply voltage

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

## 6. Functional description

#### Table 3.Functional table<sup>[1]</sup>

Operating modes	Input		Internal	Output	
	OE	СР	Dn	flip-flop	Qn
Load and read register	L	^	I	L	L
	L	↑	h	Н	Н
Load register and disable outputs	Н	↑	I	L	Z
	Н	↑	h	Н	Z

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW to HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW to HIGH CP transition

 $\uparrow$  = LOW to HIGH clock transition

Z = high-impedance OFF-state

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
Vo	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	V <sub>CC</sub> + 0.5	V
Ι <sub>Ο</sub>	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C the value of  $P_{tot}$  derates linearly with 8 mW/K.

For (T)SSOP20 packages: above 60 °C the value of  $P_{tot}$  derates linearly with 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of  $P_{tot}$  derates linearly with 4.5 mW/K.

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

## 8. Recommended operating conditions

Table 5.	Recommended operating condition	tions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	–40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{\text{CC}}$	-	-	$0.65 \times V_{\text{CC}}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	$V_{CC}$ = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
VIL	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35\times V_{CC}$	V
	$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>он</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O}$ = -8 mA; $V_{CC}$ = 2.3 V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	$V_{CC}$ = 3.6 V; $V_{\rm I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

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#### Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; \\ V_{O} = 5.5 \text{ V or GND};$	-	0.1	±10	-	±20	μA
I <sub>OFF</sub>	power-off leakage supply	$V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	0.1	±10	-	±20	μA
I <sub>CC</sub>	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA
$\Delta I_{CC}$	additional supply current	per input pin; V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to $V_{CC}$	-	5.0	-	-	-	pF

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## **10.** Dynamic characteristics

#### Table 7.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	–40 °C to +85 °C			–40 °C to +125 °C	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t <sub>pd</sub>	propagation	CP to Qn; see Figure 7	[2]						
	delay	$V_{CC} = 1.2 V$		-	17.0	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		4.6	6.4	13.1	4.6	15.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.6	3.9	7.9	2.6	9.1	ns
	$V_{CC} = 2.7 V$		1.5	3.7	8.0	1.5	10.0	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.5	7.0	1.5	9.0	ns
t <sub>en</sub> e	enable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	19.0	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	7.0	17.1	1.5	19.8	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	4.0	9.4	1.5	10.9	ns
		$V_{CC} = 2.7 V$		1.5	4.1	8.5	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.2	7.5	1.5	9.5	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	9.0	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.5	4.1	10.1	2.5	11.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.3	5.7	1.0	6.6	ns
		$V_{CC} = 2.7 V$		1.5	3.1	6.5	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.9	6.0	1.5	7.5	ns

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#### Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			-	Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t <sub>W</sub>	pulse width	clock HIGH or LOW; see Figure 7			I	I			
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.3	-	-	3.3	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		3.3	1.7	-	3.3	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Figure 8							
		$V_{CC}$ = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.0	0.3	-	2.0	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Figure 8							
		$V_{CC}$ = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		+1.5	-0.2	-	+1.5	-	ns
f <sub>max</sub>	maximum	see Figure 7							
	frequency	$V_{CC}$ = 1.65 V to 1.95 V		100	-	-	80	-	MHz
		$V_{CC}$ = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	200	-	120	-	MHz
t <sub>sk(0)</sub>	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	per flip-flop; $V_I = GND$ to $V_{CC}$	[4]						
	capacitance	$V_{CC}$ = 1.65 V to 1.95 V		-	11.2	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V		-	13.2	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	14.9	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 10</u>.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

 $t_{en}$  is the same as  $t_{\text{PZL}}$  and  $t_{\text{PZH}}.$ 

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

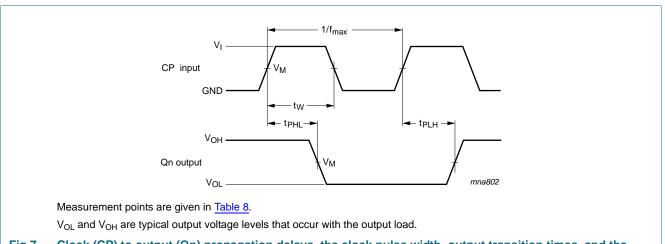
 $V_{CC}$  = supply voltage in Volts

N = number of inputs switching

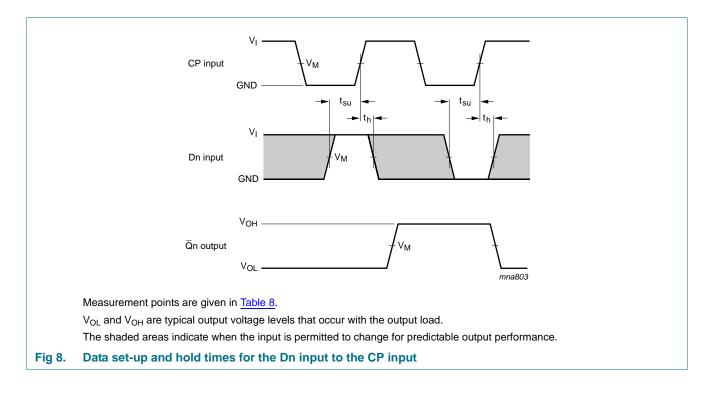
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

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## 11. AC waveforms

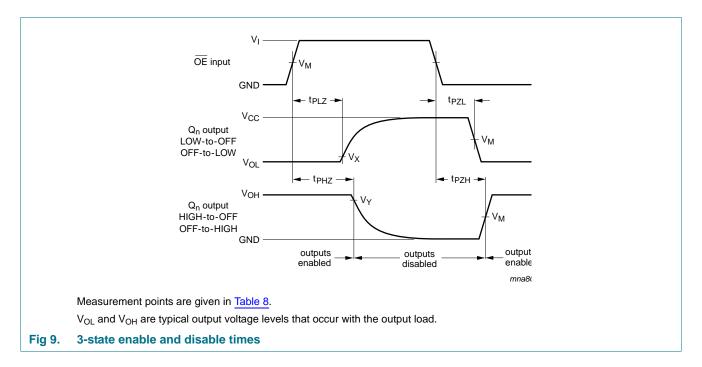


# Fig 7. Clock (CP) to output (Qn) propagation delays, the clock pulse width, output transition times, and the maximum frequency



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#### Table 8. Measurement points

Supply voltage	Input		Output			
V <sub>cc</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
1.2 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$	
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V	
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V	
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V	

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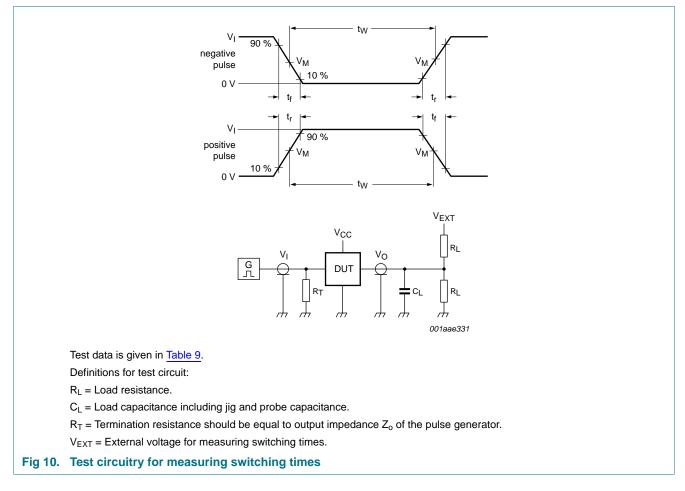
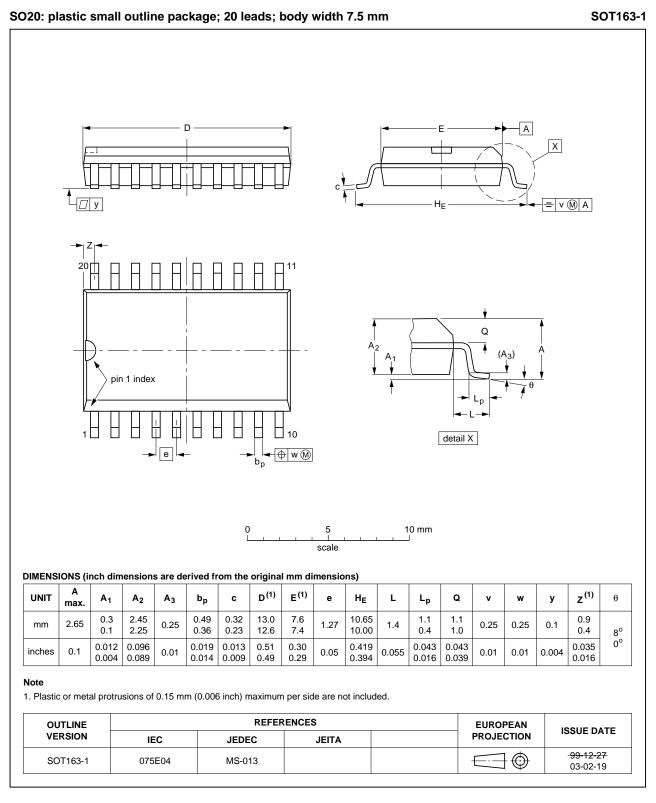


Table 9. Test dat	а							
Supply voltage	Input	Input			V <sub>EXT</sub>	V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	

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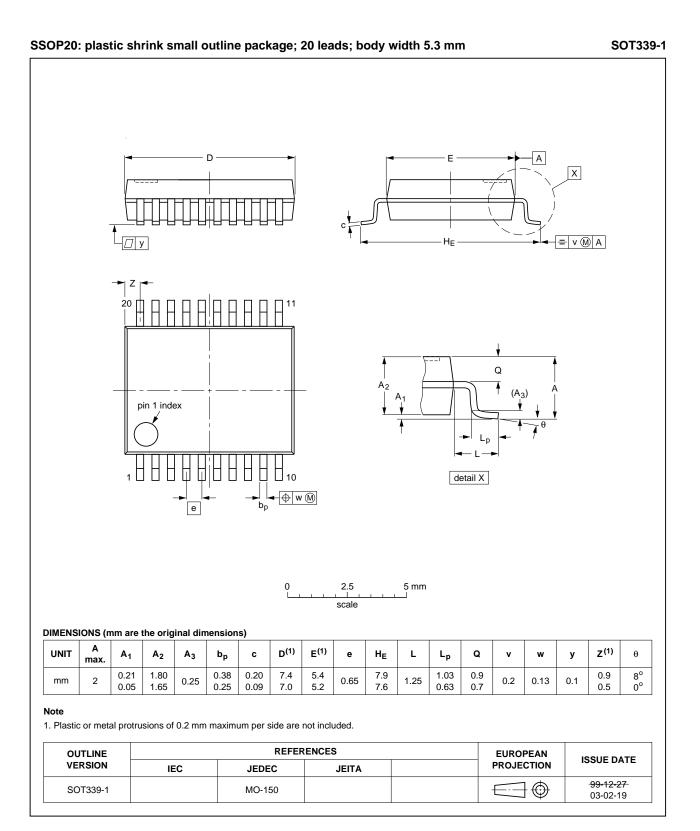
## 12. Package outline



#### Fig 11. Package outline SOT163-1 (SO20)

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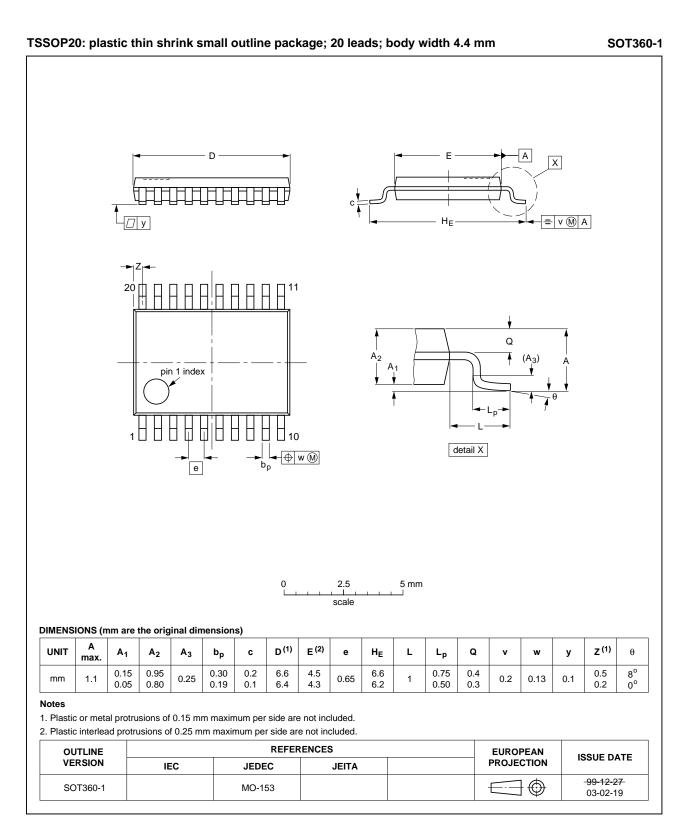
Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state



#### Fig 12. Package outline SOT339-1 (SSOP20)

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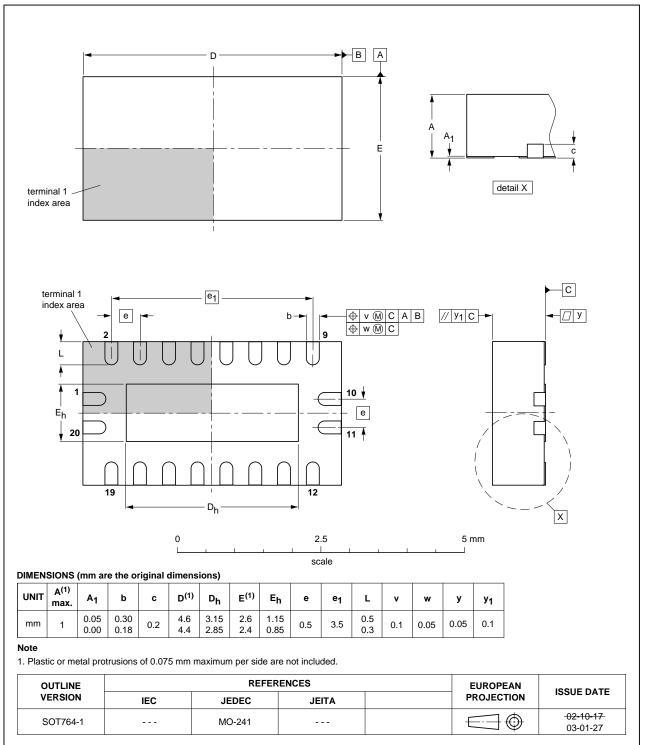
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#### Fig 13. Package outline SOT360-1 (TSSOP20)

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Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state



#### DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 14. Package outline SOT764-1 (DHVQFN20)

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

## **13. Abbreviations**

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

Table 11. Revision	history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC574A v.5	20121218	Product data sheet	-	74LVC574A v.4	
Modifications:	<ul> <li>Changed inter</li> </ul>	lacing into interfacing (errata	a) in features list.		
74LVC574A v.4	20121203	Product data sheet	-	74LVC574A v.3	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>				
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
	• Table 4, Table 5, Table 6, Table 7, Table 8 and Table 9: values added for lower voltage ranges				
74LVC574A v.3	20040322	Product specification	-	74LVC574A v.2	
74LVC574A v.2	20030620	Product specification	-	74LVC574A v.1	
74LVC574A v.1	19980729	Product specification	-	-	

## 15. Legal information

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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#### Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

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## 74LVC574A

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

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